Supplier Name: **Texas Instruments Inc. (DUNS# 00-732-1904)**
Contact Info: ti.com/support
Form/Declaration Type: **Distribute - RoHS and IEC 62474 DB**
Created on: **06/12/2022**

Details for "TPS7A2055PDBVR"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package | Pins	Package body size (mm)	Total device mass (mg)*
TPS7A2055PDBVR	SN	Level-1-260C-UNLIM	Ext-Mfg	DBV | 5	2.9x1.6x1.45	19

***Total Device Mass**
The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

Component Information

				Homogeneous Material Level		Component Level	
Component	**Substance**	**CAS Number**	**Amount (mg)**	**Percentage %**	**ppm**	**Percentage %**	**ppm**
Bond Wire							
Copper and Its Alloys	Copper	7440-50-8	0.015593	97.389295	973893	0.082186	822
Precious Metals	Gold	7440-57-5	0.000034	0.212354	2124	0.000179	2
Precious Metals	Palladium	7440-05-3	0.000384	2.398351	23984	0.002024	20
Sub-Total			**0.016011**	**100**	**1000000**	**0.084389**	**844**
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	0.069717	80.000229	800002	0.367458	3675
Thermoplastics	Epoxy	85954-11-6	0.017429	19.999771	199998	0.091863	919
Sub-Total			**0.087146**	**100**	**1000000**	**0.459321**	**4593**
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	6.632428	97.535706	975357	34.95756	349576
Copper and Its Alloys	Iron	7439-89-6	0.153136	2.252	22520	0.807134	8071
Copper and Its Alloys	Phosphorus	7723-14-0	0.001496	0.022	220	0.007885	79
Precious Metals	Silver	7440-22-4	0.004304	0.063294	633	0.022685	227
Zinc and Its Alloys	Zinc	7440-66-6	0.008636	0.127	1270	0.045518	455
Sub-Total			**6.8**	**100**	**1000000**	**35.840783**	**358408**
Lead Frame Plating							
Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.04	100	1000000	0.210828	2108
Sub-Total			**0.04**	**100**	**1000000**	**0.210828**	**2108**
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	10.283509	86.85	868500	54.201325	542013
Other Organic Materials	Proprietary Non Halide Flame Retardant	Trade Secret	0.059203	0.500003	5000	0.312041	3120
Other Plastics and Rubber	Carbon Black	1333-86-4	0.017761	0.150002	1500	0.093613	936
Thermoplastics	Epoxy	85954-11-6	1.480067	12.499996	125000	7.800994	78010
Sub-Total			**11.84054**	**100**	**1000000**	**62.407974**	**624080**
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	0.189103	100	1000000	0.996706	9967
Sub-Total			**0.189103**	**100**	**1000000**	**0.996706**	**9967**
Total			18.9728			100	1000000

Important Note
The ppm calculations are at the **homogeneous material** level and are maximum concentration values. The ppm displayed represents the **homogeneous material** with the highest ppm for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.
The ppm calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the **component**.
See Glossary of Terms for more details.

Important Part Information
There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology
For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

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TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."
For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality
For further environmental statements, please go to www.ti.com/ecoinfo
Created on: 06/12/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, Tl semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. Tl may also reference these types of semiconductor products as "Pb-Free." These Tl semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (Cl) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.